

CMS MTD BTL Sensor R&D and Assembly in Phase2 Upgrade

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第十届中国LHC物理会议(CLHCP2024 青岛), 11/14/2024



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• CMS MTD BTL Detector for HL-LHC

- BTL Sensor R&D and Test Beam
- BTL Assembly and Local Lab Setups at PKU

Summary





01 CMS MTD BTL detector for HL-LHC



Physics motivation of MTD

High luminosity → High pileup

The MTD is a new CMS Phase-II detector for the HL-LHC. It will be added to CMS to help meet the challenge of high luminosity.

HL-LHC, 3000 fb⁻¹ at the cost of 140-200 simultaneous collisions (PU)
MTD + upgraded tracker = Run2-esque PU mitigation



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MTD can effectively suppress pileup, improving the overall accuracy of physical measurements.

- > It improves the precision of single Higgs measurements by 20-30%.
- > It increases the acceptance of Di-Higgs signals by 20%.

MTD provides TOF information.

- > It reduces reducible background by 40% in the search for SUSY particles.
- ➤ It significantly enhances sensitivity to long-lived particles.

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Composition and Highlights of MTD

BTL and ETL

• Choice of sensor technologies for barrel and endcap timing layers driven by technology maturity, radiation hardness, power consumption, and cost and schedule considerations.



Highlights

- ✓ The MTD BTL is the first time that CMS barrel has achieved a time resolution of tens of picoseconds
- ✓ CMS will be the only large-scale universal detector on the LHC that measures tens of picoseconds of time in the barrel section



BTL is a single-layer MIP detector located in-between the outer tracker (OT) and the inner wall of the BTL-Tracker Support Tube (BTST).

It will measure time with ~30-60ps resolution.

- $\succ\,$ Thin (< 4 cm), large area (38 m²) detector covering $|\eta|<1.5$
- ➤ ~10k Sensor Modules, each containing 16 LYSO crystal bars and two 16-channel SiPM arrays
- Read out with custom TOFHIR2 ASIC
- ➢ Mounted on CO2 cooled trays and installed on inner surface of BTL Tracker Support Tube (BTST)





02 BTL Sensor R&D and Test Beam

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Test Beam for BTL Sensor R&D

Analysis of the time resolution of BTL module using minimum ionizing particles.

Setup:

Conducted on CERN (180 GeV pion) and FNAL (120 GeV proton) beams

The time resolution is well modeled as a function of few SiPM parameters:

• gain, PDE and DCR

The optimal choice of SiPM and LYSO:

> 25 μ m SiPM cell size from HPK SiPM and 3.75 mm thick LYSO

Such a sensor module configuration achieves a time resolution of about

- > 25 ps with non-irradiated SiPMs
- 60 ps under the irradiation, annealing and temperature conditions representative of the end of the BTL detector operation

>> Optimization of LYSO and SiPM paper submitted to JINST







Test Beam Study by PKU : SiPM R&D

SiPM

- ➢ Main optimization and research parameters: Cell size of SiPM
 - The time resolution for modules with non-irradiated SiPMs of different cell-sizes (15, 20, 25 μm)
 - \geq 25 µm has the best time resolution
- More tests were conducted, such as comparing the time resolution of SiPM from different manufacturers
- Optimization of SiPM parameters has been completed









Test Beam Study by PKU : LYSO R&D

LYSO

- Preliminary comparative tests were conducted on the quality of LYSO (size, yield, etc.) from various manufacturers
- Finally, perform time resolution testing on high-performance manufacturers using beam current
- The time resolution of manufacturers Prod1 and Prod5 was compared as follows
- LYSO optimization has been completed



Results are measured at the optimal threshold

LYSO	Vov/V	angle/deg t _{Res} /ps		error/%
		32	38.2	6.9
prod1	1.50	52 32.2		3.1
		64	30.9	9.0
	3.50	32	25.7	2.1
		52	23.5	1.2
		64	23.6	7.2
prod5	1.50	50	35.1	4.3
	3.50	52	24.6	4.0

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03 BTL Assembly and Local Lab Setups at PKU



Schedule of MTD BTL

Assembly timeline

- Testbeam of sensor in 2023
- Improved the assembly and QA/QC in 2023 & 2024
- Assembly Center Certification in 2024
- Start batch assembly in the Autumn of 2024
- \succ End assembly in 2025

382	Module production batch 4	January 7, 2025 Feb 7,	025 2.76 weeks	Module production batch 4
383	Module production batch 5	Feb 7, 2025 Mar 11	2025 3.1w	Module production batch 5
384	Module production batch 6	March 11, 2025 April 1	2025 3.38 weeks	Module production bate
385	Module production batch 7	April 11, 2025 May 13	2025 3.7 weeks	Module productio
386	Module production batch 8	May 13, 2025 June 1	2025 1m	Module pro
387	Module production batch 9	June 12, 2025 July 15	2025 1.1m	Modul
388	B.A. 3.2 Finish of module production	July 15, 2025 July 15	2025 1.1m	B.A. 3.2 Fir
389	Tray production & assembly	Nov 18, 2024 Sep 16	2025 0 days	Tray production & assembly
390	B.A.4.0 Tray production starts	Nov 18, 2024 Nov 18	2024 2w	B.A.4.0 Tray production starts
391	Tray production batch 1 - module mounting	Nov 18, 2024 Dec 6,	2024 2w	Tray production batch 1 - module mounting
392	Tray production batch 1 - CC, cabling, testing	Dec 27, 2024 Jan 9,	025 0 days	Tray production batch 1 - CC, cabling, testing
393	Tray production batch 2 - module mounting	Dec 6, 2024 Dec 26	2024 2.02 weeks	Tray production batch 2 - module mounting
394	Tray production batch 2 - CC, cabling, testing	Jan 10, 2025 Jan 23	2025 0 days	Tray production batch 2 - CC, cabling, testing
395	B.A.4 Tray production 25% done	Jan 23, 2025 Jan 23	2025 0 days	B.A.4 Tray production 25% done
396	Tray production batch 3 - module mounting	Jan 24, 2025 Feb 12	2025 0 days	Tray production batch 3 - module mounting
397	Tray production batch 3 - CC, cabling, testing	Feb 13, 2025 Feb 26	2025 0 days	Tray production batch 3 - CC, cabling, testing
398	Tray production batch 4 - module mounting	Feb 27, 2025 Mar 18	2025 0 days	Tray production batch 4 - module mountin
399	Tray production batch 4 - CC, cabling, testing	March 19, 2025 April 1,	2025 0 days	Tray production batch 4 - CC, cabling, te
400	B.A.5 Tray production 50% done	April 1, 2025 April 1	2025 0 days	B.A.5 Tray production 50%
401	Tray production batch 5 - module mounting	April 2, 2025 April 2	2025 0 days	Tray production batch 5 - module m
402	Tray production batch 5 - CC, cabling, testing	April 22, 2025 May 5,	025 0 days	Tray production batch 5 - CC, cat
403	Tray production batch 6 - module mounting	May 6, 2025 May 23	2025 0 days	Tray production batch 6 - mos
404	Tray production batch 6 - CC, cabling, testing	May 26, 2025 June 6	2025 0 days	Tray production batch 6 - C
405	Tray production batch 7 - module mounting	June 9, 2025 June 2	2025 0 days	Tray production batch
406	Tray production batch 7 - CC, cabling, testing	June 27, 2025 July 10	2025 0 days	Tray production batc
407	Tray production batch 8 - module mounting	July 11, 2025 July 30	2025 0 days	Tray production
408	Tray production batch 8 - CC, cabling, testing	July 31, 2025 Aug 13	2025 0 days	Tray productio
409	Tray production batch 9 - module mounting	Aug 14, 2025 Sep 2,	025 0 days	Tray proc
410	Tray production batch 9 - CC, cabling, testing	Sep 3, 2025 Sep 16	2025 0 days	Tray pr
411	B.A.6 Tray production 100% finshed	Sep 16, 2025 Sep 16	2025 0 days	
412	BTL Integration	Nov 18, 2024 Mar 8,	2028 0 days	BTL Integration
413	TIF preparation for integration	Nov 18, 2024 May 1	2025 -4.2h	TIF preparation for integration
414	TIF preparation for integration	Jan 30, 2025 Mar 27	2025 -4.2h	TIF preparation for integration
415	BE prototype intalled in TIF	Nov 18, 2024 Jan 13	2025 2.6m	BE prototype intalled in TIF
416	Tray test insertion	Mar 27, 2025 May 1,	2025 -4.2h	Tray test in:
417	B.A.7.0 TIF ready for BTL integration	May 1, 2025 May 1,	2025 -4.2h	B.A.7.0 TIF ready for BTL
418	TST integration	May 1, 2025 July 2	2027 0 days	TST
419	B.A.7 Start of TST integation	May 1, 2025 May 1,	2025 -4.2h	B.A.7 Start of TS
420	TST+ integration	May 1, 2025 July 2	2025 -4.2h	TST
421	Insert batch 1 of 6 trays	May 1, 2025 May 14	2025 -4.2h	Insert batc
422	Connecting batch 1 of 6 trays	May 14, 2025 May 2	2025 -4.2h	Connecting ba
423	Insert batch 2	May 14, 2025 May 2	2025 -4.2h	
424	Connect batch 2	May 27, 2025 June 9	2025 -4.2h	
425	Insert batch 3	May 27, 2025 June 9	2025 -4.2h	
426	Connect batch 3	June 9, 2025 June 2	, 2025 -4.2h	
427	Insert batch 4	June 9, 2025 June 2	, 2025 -4.2h	
428	Connect batch 4	June 20, 2025 July 3	2025 -4.2h	
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Assembly of MTD BTL







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Cooling plate assembly and QC is ongoing at CERN

All components are assembled and validated at 4 global BTL Assembly Centers (BACs)

- Virginia
- Caltech
- Milan
- Beijing

Trays will be shipped to CERN, integrated into the BTST

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PKU Lab Setups for BTL Assembly and QAQC (の) いまえま

SM glued and tools

Assembly and QA/QC of Sensor Module

Assembly of Sensor Module

Assembly materials

- **RTV** with a high refractive index close to that of LYSO **Assembly tool : GAMBIT**
- Control RTV thickness, SiPM/LYSO alignment, and others
- Standardization of Assembly flow
- The humidity, time, and other ranges for placing the module

QA/QC of Sensor Module

- measure the light yield of each channel to show the assembly quality
- Components: Electronic module, constant temperature dark box, data collection system, and source movement system

<u>In Leyan's talk</u>







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Assembly and QA/QC of Sensor Module



avg. channel light output [pe/MeV]

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Batch production of QAQC boards

Assembly and QA/QC of Detector Module

Detector Module : Sensor module, FE front-end electronic board, and copper shell for heat exchange

Assembly process of DM: Thermal contact

- ➢ Good contact between the outer end of TEC on SiPM and the copper
- Coverage of thermal pads on important chip surfaces on FE board
- Avoid contact between LYSO crystals and other components

QA/QC of the DM mainly involves thermal coupling testing









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Assembly and QA/QC of BTL Tray

MTD BTL Tray

- A BTL Tray will cover a detector range of 10 degrees and 2.5 meters at η
- A total of 72 Trays cover the entire barrel of the MTD time detector

Assembly of BTL Tray

 6 RUs, each includes a cooling plate, CC board, PCC board, and 12 DMs.

The tray QA/QC system based on Serenity board and custom tray powering board is currently being established. Powering board







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Research and Workshop on BTL assembly





The first complete detector module was produced at CERN by the end of 2023

for the manufacturing process of detector modules



In March 2024 at CERN, Complete the assembly of the whole RU for the first time



Completed the assembly of the entire Tray for the first time, QA/QC was carried out, and the assembly process was basically determined

- BTL production is moving ahead according to the latest schedule!
- For the latest progress on BTL work, please refer to <u>Karlis</u>.

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04 Summary

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- MTD, a new CMS Phase-II detector for the HL-LHC will be added to CMS to help meet the challenge of high luminosity.
 - ✓ BTL is a single-layer MIP detector which will measure time with \sim 30-60 ps resolution.
- ➢ For PKU, We actively participate in the comprehensive work of MTD BTL, and, as one of the assembly centers, undertake 1/4 of the assembly work.
 - ✓ In terms of BTL Sensor R&D, we mainly conducted research on the cell size, manufacturers of SiPM and manufacturers of LYSO.
 - ✓ Assembly and QAQC work is currently underway at PKU !
- > THU and BUAA also started learning up the assembly !
- > BTL is not "moving to production", BTL is "in production".
 - ✓ We are confident that BTL will be the first fully completed CMS Phase-2 sub-detector come 4th November 2025.

Thanks for your attention!







Back up

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Experiment	r	σ_{T}	$r/\sigma_{\rm T}$ (×100)
	(m)	(ps)	$(m \times ps^{-1})$
STAR-TOF	2.2	80	2.75
ALICE-TOF	3.7	56	6.6
CMS-MTD	1.16	30	3.87

Table 1.3: Nominal radiation doses and fluences at various locations of the timing layers after 3000 fb^{-1} . The last two columns show the radiation levels providing a safety margin of a factor 1.5. The fluence is normalized to 1 MeV neutron equivalent in silicon.

				3000) fb ⁻¹	1.5×30	100 fb^{-1}
Region	$ \eta $	<i>r</i> (cm)	<i>z</i> (cm)	n _{eq} /cm ²	Dose (kGy)	n _{eq} /cm ²	Dose (kGy)
Barrel	0.0	116	0	1.65×10^{14}	18	2.48×10^{14}	27
Barrel	1.15	116	170	1.80×10^{14}	25	2.70×10^{14}	38
Barrel	1.45	116	240	1.90×10^{14}	32	2.85×10^{14}	48
Endcap	1.6	127	303	1.5×10^{14}	19	2.3×10^{14}	29
Endcap	2.0	84	303	3.0×10^{14}	50	4.5×10^{14}	75
Endcap	2.5	50	303	7.5×10^{14}	170	1.1×10^{15}	255
Endcap	3.0	31.5	303	1.6×10^{15}	450	2.4×10^{15}	675

Table 1.1: Expected scientific impact of the MIP Timing Detector, taken from Ref. [8].

Signal	Physics measurement	MTD impact
$H \rightarrow \gamma \gamma$ and	+15-25% (statistical) precision on the cross section	Isolation and
$H \rightarrow 4$ leptons	\rightarrow Improve coupling measurements	Vertex identification
$VBF \rightarrow H \rightarrow \tau \tau$	+30% (statistical) precision on cross section	Isolation
	ightarrow Improve coupling measurements	VBF tagging, $p_{\rm T}^{\rm miss}$
HH	+20% gain in signal yield	Isolation
	\rightarrow Consolidate searches	b-tagging
EWK SUSY	+40% background reduction	MET
	\rightarrow 150 GeV increase in mass reach	b-tagging
Long-lived	Peaking mass reconstruction	$\beta_{\rm LLP}$ from timing of
particles (LLP)	\rightarrow Unique discovery potential	displaced vertices